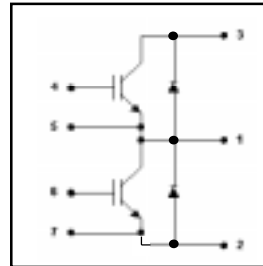


Features

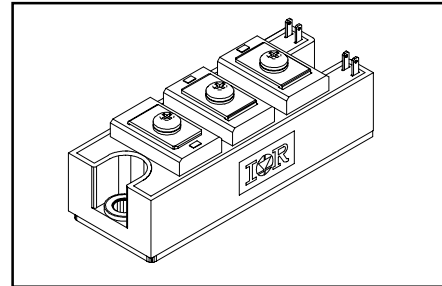
- Generation 4 IGBT technology
- Standard: Optimized for minimum saturation voltage and operating frequencies up to 10kHz
- Very low conduction and switching losses
- HEXFRED™ antiparallel diodes with ultra- soft recovery
- Industry standard package
- UL approved



$V_{CES} = 1200V$
 $V_{CE(on) typ.} = 2.4V$
@ $V_{GE} = 15V, I_C = 150A$

Benefits

- Increased operating efficiency
- Direct mounting to heatsink
- Performance optimized for power conversion: UPS, SMPS, Welding
- Lower EMI, requires less snubbing



Absolute Maximum Ratings

	Parameter	Max.	Units
V_{CES}	Collector-to-Emitter Voltage	1200	V
$I_C @ T_C = 25^\circ C$	Continuous Collector Current	150	A
I_{CM}	Pulsed Collector Current①	300	
I_{LM}	Peak Switching Current②	300	
I_{FM}	Peak Diode Forward Current	300	
V_{GE}	Gate-to-Emitter Voltage	± 20	V
V_{ISOL}	RMS Isolation Voltage, Any Terminal To Case, $t = 1 \text{ min}$	2500	
$P_D @ T_C = 25^\circ C$	Maximum Power Dissipation	780	W
$P_D @ T_C = 85^\circ C$	Maximum Power Dissipation	406	
T_J	Operating Junction Temperature Range	-40 to +150	$^\circ C$
T_{STG}	Storage Temperature Range	-40 to +125	

Thermal / Mechanical Characteristics

	Parameter	Typ.	Max.	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case - IGBT	—	0.16	$^\circ C/W$
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case - Diode	—	0.20	
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink - Module	0.1	—	
	Mounting Torque, Case-to-Heatsink	—	4.0	N·m
	Mounting Torque, Case-to-Terminal 1, 2 & 3③	—	3.0	
	Weight of Module	400	—	g

Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(BR)CES}$	Collector-to-Emitter Breakdown Voltage	1200	—	—	V	$V_{GE} = 0V, I_C = 1mA$
$V_{CE(on)}$	Collector-to-Emitter Voltage	—	2.4	2.9		$V_{GE} = 15V, I_C = 150A$
		—	2.2	—		$V_{GE} = 15V, I_C = 150A, T_J = 125^\circ\text{C}$
$V_{GE(th)}$	Gate Threshold Voltage	3.0	—	6.0		$I_C = 1.75mA$
$\Delta V_{GE(th)}/\Delta T_J$	Temperature Coeff. of Threshold Voltage	—	-11	—	mV/ $^\circ\text{C}$	$V_{CE} = V_{GE}, I_C = 1.75mA$
g_{fe}	Forward Transconductance ④	—	201	—	S	$V_{CE} = 25V, I_C = 150A$
I_{CES}	Collector-to-Emitter Leaking Current	—	—	2	mA	$V_{GE} = 0V, V_{CE} = 1200V$
		—	—	20		$V_{GE} = 0V, V_{CE} = 1200V, T_J = 125^\circ\text{C}$
V_{FM}	Diode Forward Voltage - Maximum	—	2.7	3.5	V	$I_F = 150A, V_{GE} = 0V$
		—	2.6	—		$I_F = 150A, V_{GE} = 0V, T_J = 125^\circ\text{C}$
I_{GES}	Gate-to-Emitter Leakage Current	—	—	500	nA	$V_{GE} = \pm 20V$

Dynamic Characteristics - $T_J = 125^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
Q_g	Total Gate Charge (turn-on)	—	1139	1709	nC	$V_{CC} = 400V, V_{GE} = 15V$
Q_{ge}	Gate - Emitter Charge (turn-on)	—	192	288		$I_C = 171A$
Q_{gc}	Gate - Collector Charge (turn-on)	—	377	566		$T_J = 25^\circ\text{C}$
$t_{d(on)}$	Turn-On Delay Time	—	414	—	ns	$R_{G1} = 15\Omega, R_{G2} = 0\Omega$
t_r	Rise Time	—	208	—		$I_C = 150A$
$t_{d(off)}$	Turn-Off Delay Time	—	552	—		$V_{CC} = 720V$
t_f	Fall Time	—	342	—		$V_{GE} = \pm 15V$
E_{on}	Turn-On Switching Energy	—	29	—	mJ	See Fig.17 through Fig.21
E_{off}	Turn-Off Switching Energy	—	32	—		
E_{ts}	Total Switching Energy	—	61	90		
C_{ies}	Input Capacitance	—	25630	—	pF	$V_{GE} = 0V$
C_{oes}	Output Capacitance	—	1139	—		$V_{CC} = 30V$
C_{res}	Reverse Transfer Capacitance	—	221	—		$f = 1MHz$
t_{rr}	Diode Reverse Recovery Time	—	186	—	ns	$I_C = 150A$
I_{rr}	Diode Peak Reverse Current	—	133	—	A	$R_{G1} = 15\Omega$
Q_{rr}	Diode Recovery Charge	—	12381	—	nC	$R_{G2} = 0\Omega$
$di_{(rec)}/dt$	Diode Peak Rate of Fall of Recovery During t_b	—	2524	—	A/ μs	$V_{CC} = 720V$ $di/dt = 1260A/\mu s$

Details of note ① through ④ are on the last page

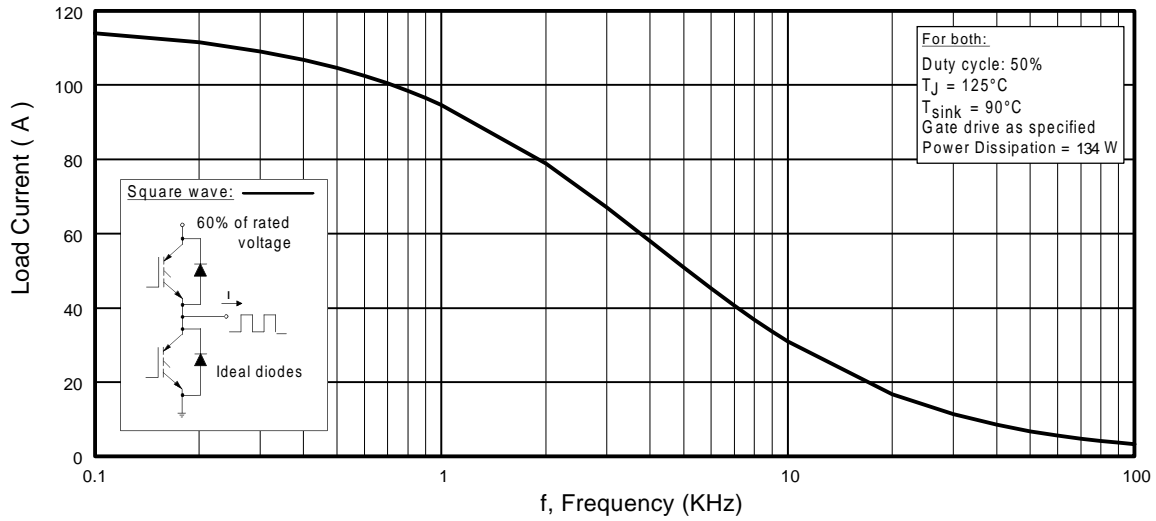


Fig. 1 - Typical Load Current vs. Frequency
(Load Current = I_{RMS} of fundamental)

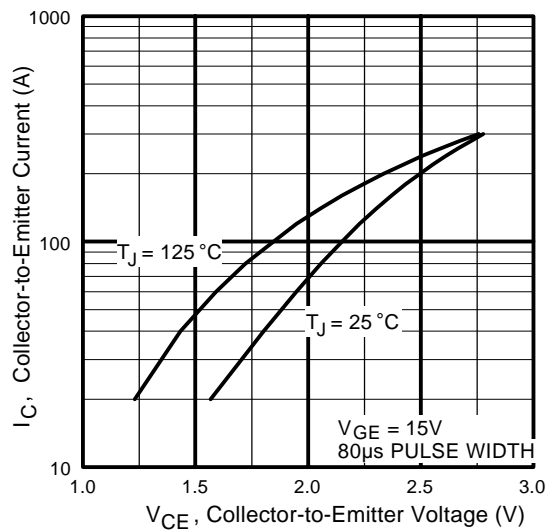


Fig. 2 - Typical Output Characteristics

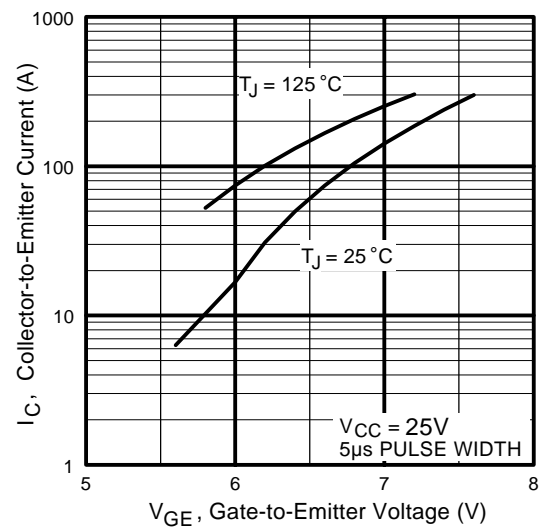


Fig. 3 - Typical Transfer Characteristics

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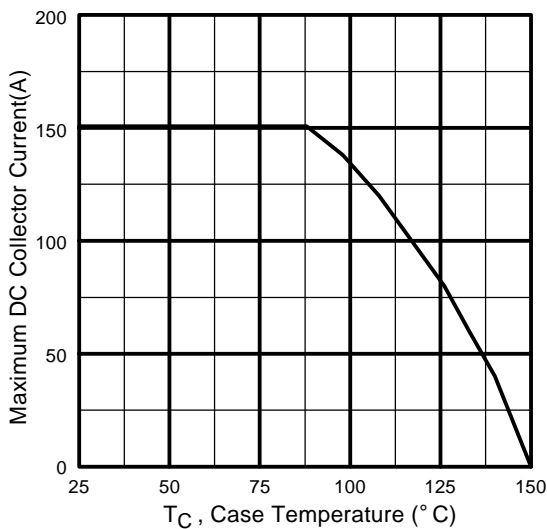


Fig. 4 - Maximum Collector Current vs. Case Temperature

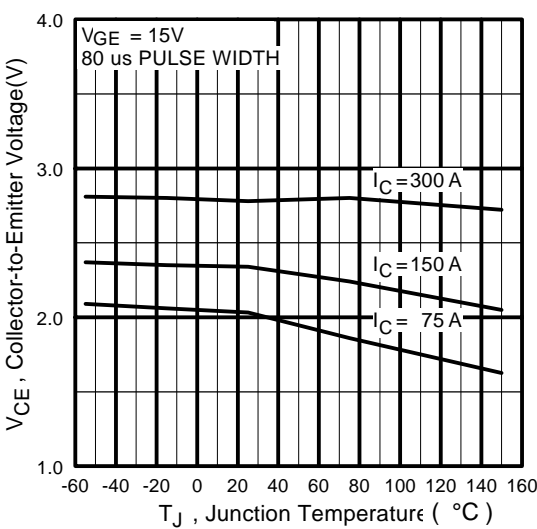


Fig. 5 - Typical Collector-to-Emitter Voltage vs. Junction Temperature

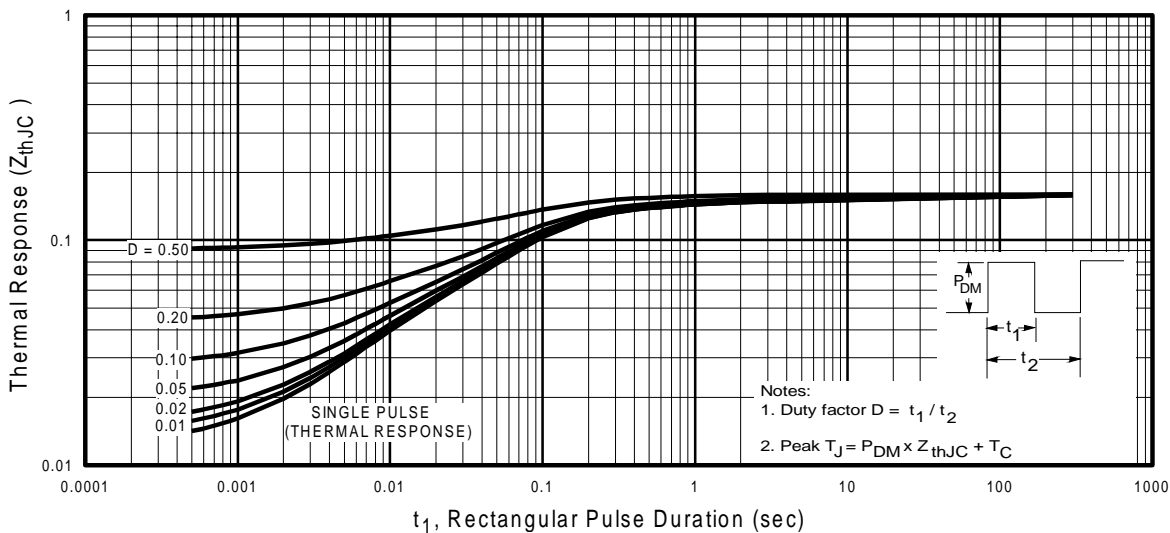


Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

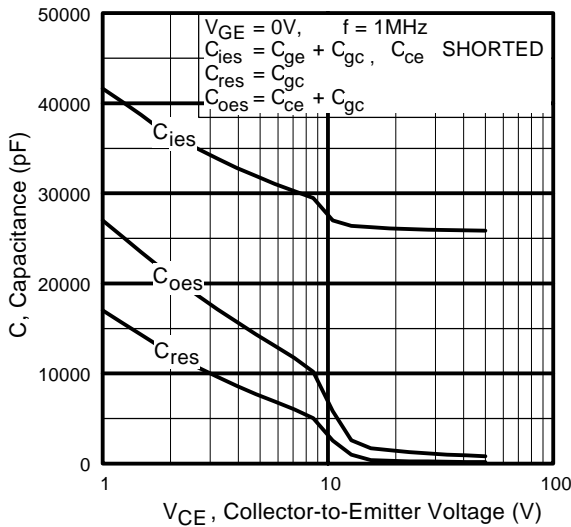


Fig. 7 - Typical Capacitance vs. Collector-to-Emitter Voltage

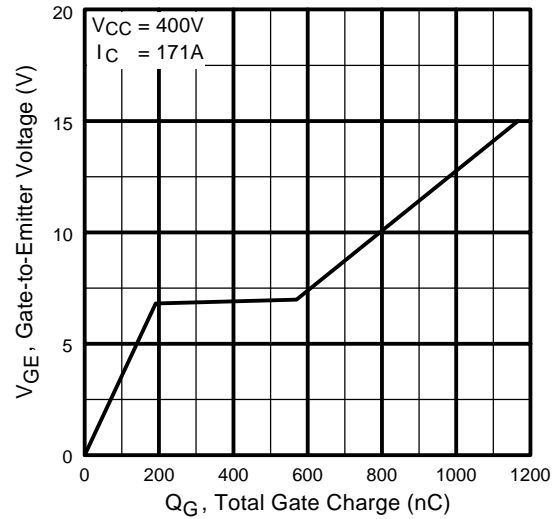


Fig. 8 - Typical Gate Charge vs. Gate-to-Emitter Voltage

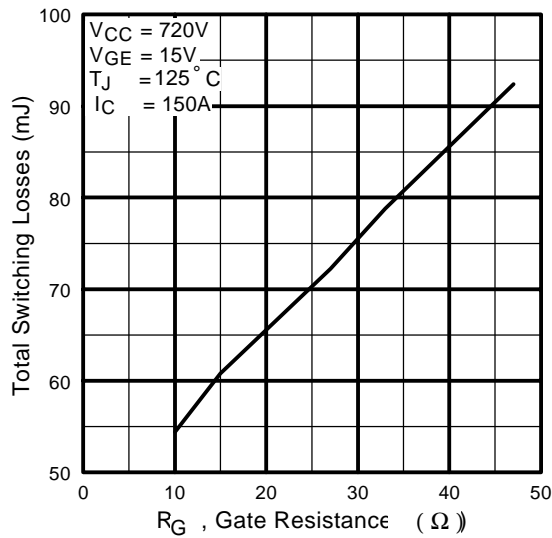


Fig. 9 - Typical Switching Losses vs. Gate Resistance

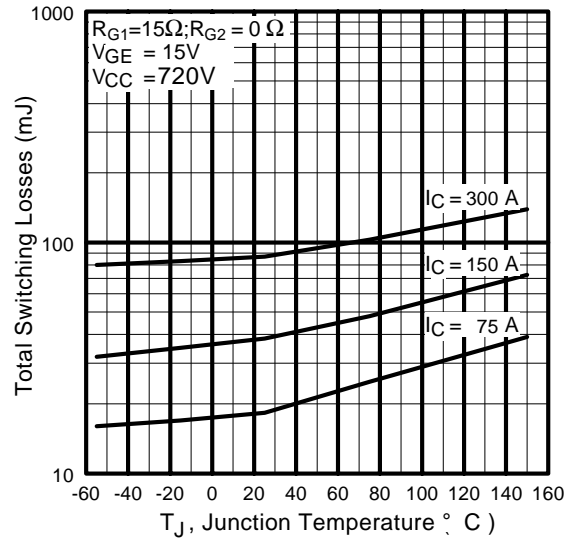
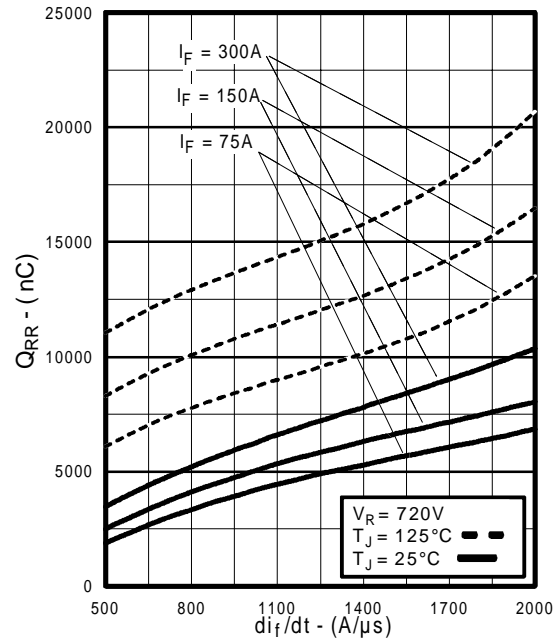
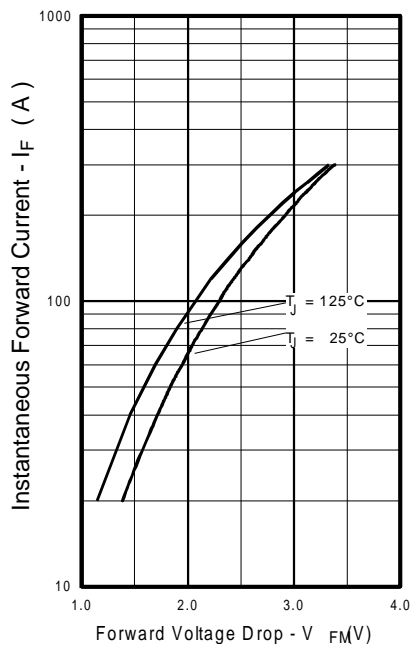
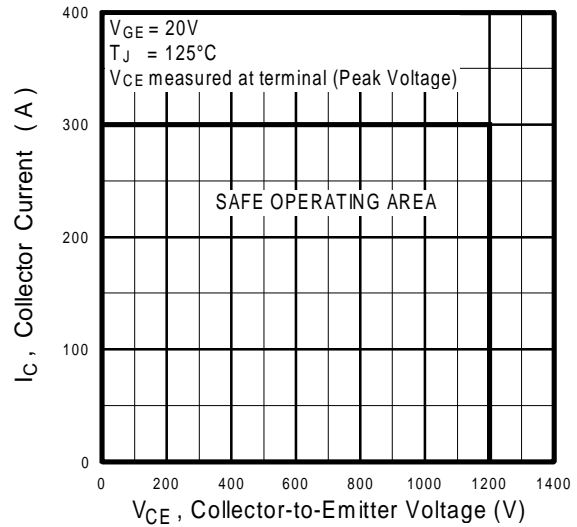
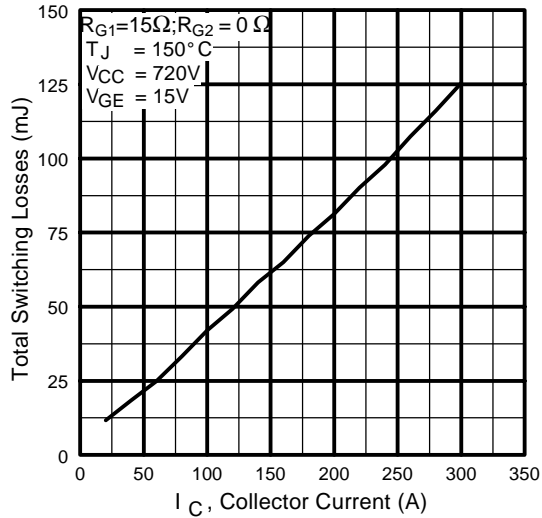


Fig. 10 - Typical Switching Losses vs. Junction Temperature

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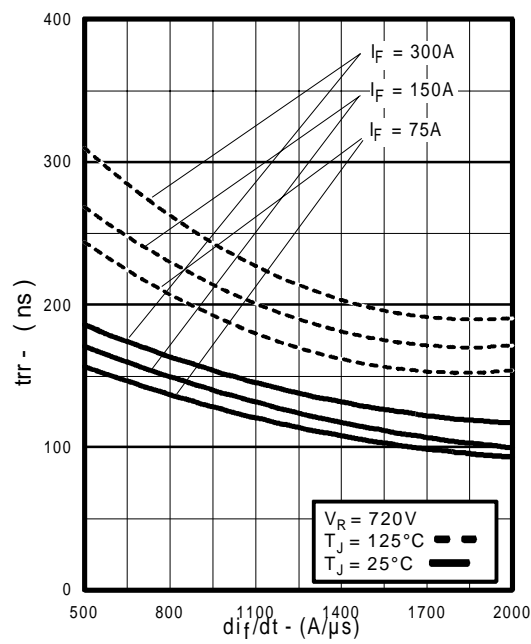


Fig. 15 - Typical Reverse Recovery vs. di_T/dt

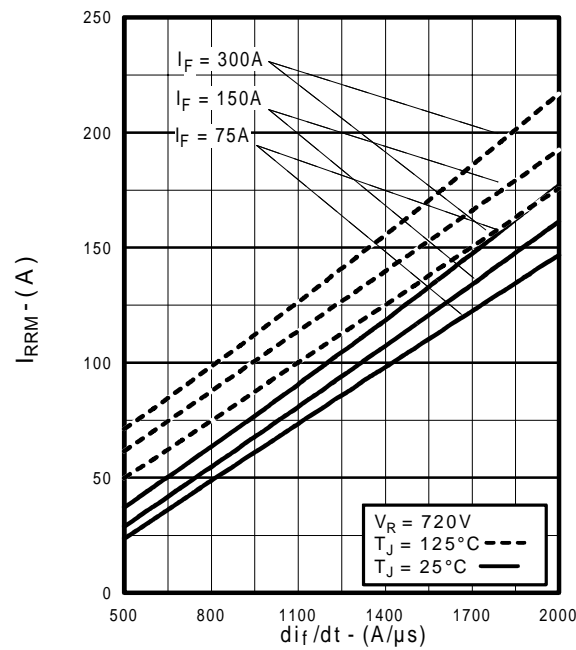


Fig. 16 - Typical Recovery Current vs. di_T/dt

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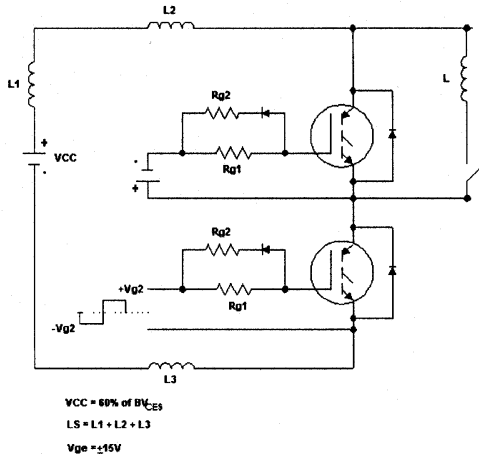


Fig. 17 - Test Circuit for Measurement of I_{LM} , E_{on} , $E_{off}(\text{diode})$, t_{rr} , Q_{rr} , I_{rr} , $t_{d(on)}$, t_r , $t_{d(off)}$, t_f

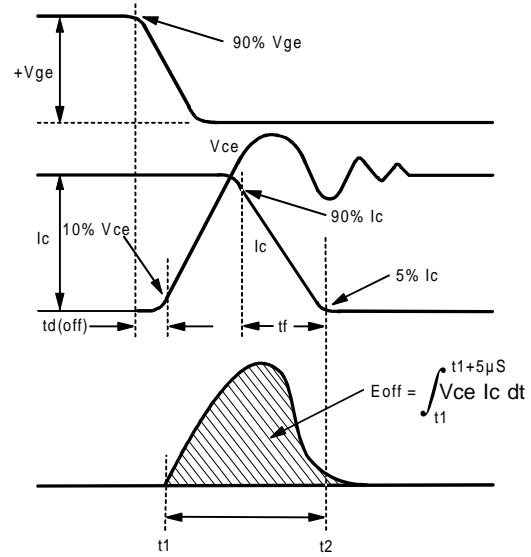


Fig. 18 - Test Waveforms for Circuit of Fig. 17, Defining E_{off} , $t_{d(off)}$, t_f

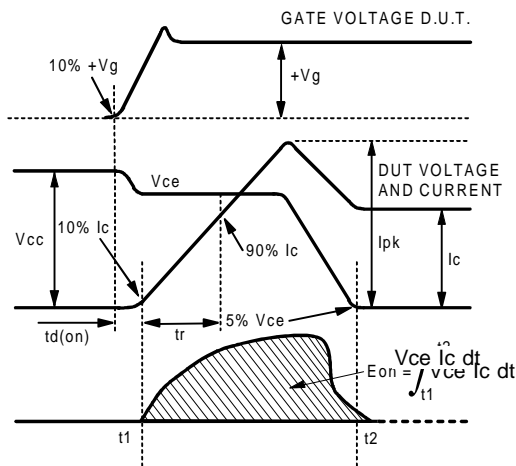


Fig. 19 - Test Waveforms for Circuit of Fig. 17, Defining E_{on} , $t_{d(on)}$, t_r

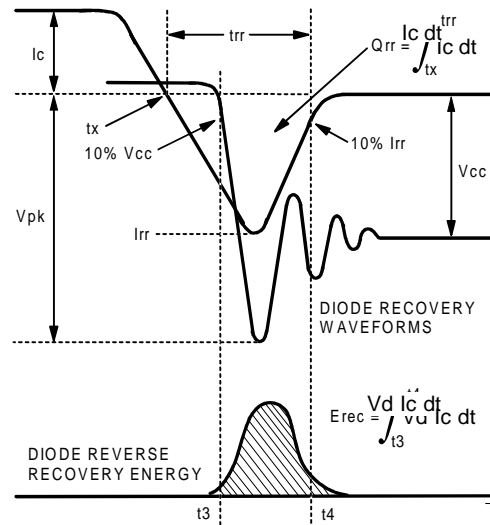


Fig. 20 - Test Waveforms for Circuit of Fig. 17, Defining E_{rec} , t_{rr} , Q_{rr} , I_{rr}

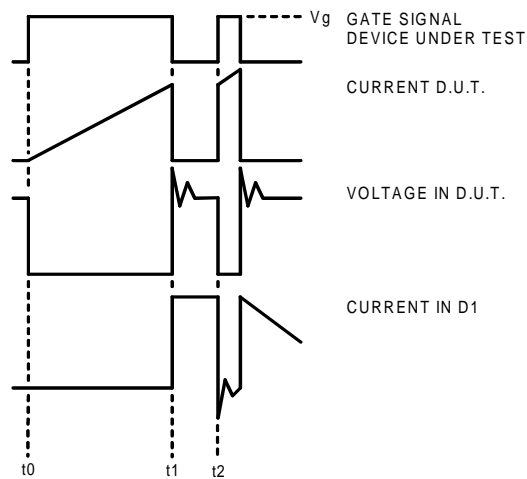


Figure 21. Macro Waveforms for Figure 17's Test Circuit

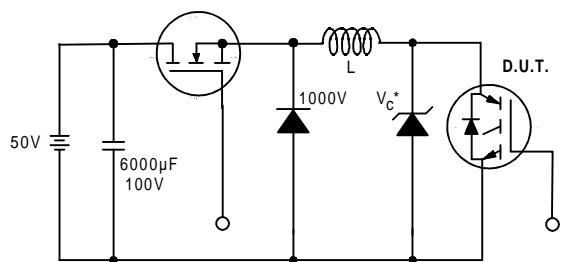


Figure 18. Clamped Inductive Load Test Circuit

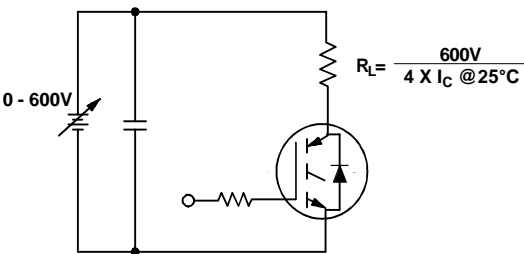


Figure 22. Pulsed Collector Current Test Circuit

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- ① Repetitive rating; $V_{GE} = 20V$, pulse width limited by max. junction temperature.
- ② See fig. 17
- ③ For screws M5x0.8
- ④ Pulse width 80 μ s; single shot.

Technical drawing of the 3000 Series 3-Phase Motor showing three views: front, side, and top. The front view shows a motor with three phase windings labeled 1, 2, and 3. Dimensions include overall width (108.75 mm), mounting flange diameter (107.25 mm), and terminal spacing (93.3 mm). The side view shows the motor's profile with dimensions for the mounting flange (54.5 mm) and the terminal box (25.0 mm). The top view shows the motor's base with dimensions for the mounting flange (54.5 mm) and the terminal box (25.0 mm).

Dimensions are shown in millimeters (inches)

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